

0.9-Ω SPST ANALOG SWITCH

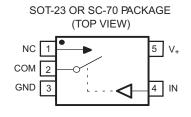
Check for Samples: TS5A3166

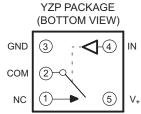
FEATURES

- Isolation in Powered-Off Mode, V₊ = 0
- Low ON-State Resistance (0.9 Ω)
- Control Inputs Are 5.5-V Tolerant
- Low Charge Injection
- Low Total Harmonic Distortion (THD)
- 1.65-V to 5.5-V Single-Supply Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)

APPLICATIONS

- Cell Phones
- PDAs
- Portable Instrumentation
- Audio and Video Signal Routing
- Low-Voltage Data-Acquisition Systems
- Communication Circuits
- Modems
- Hard Drives
- Computer Peripherals
- Wireless Terminals and Peripherals
- Microphone Switching Notebook Docking





DESCRIPTION/ORDERING INFORMATION

The TS5A3166 is a single-pole single-throw (SPST) analog switch that is designed to operate from 1.65 V to 5.5 V. The device offers a low ON-state resistance. The device has excellent total harmonic distortion (THD) performance and consumes very low power. These features make this device suitable for portable audio applications.

ORDERING INFORMATION

| T _A | PACKAGE ⁽¹⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING (2) |
|----------------|--|---------------|------------------------------|----------------------|
| | NanoFree [™] – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb- free) | Tape and reel | TS5A3166YZPR | JF_ |
| -40°C to 85°C | NanoFree [™] – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb- free) | Tape and reel | TS5A3166YZPRB ⁽³⁾ | JF_ |
| | SOT (SOT-23) – DBV | Tape and reel | TS5A3166DBVR | JAT_ |
| | SOT (SC-70) - DCK | Tape and reel | TS5A3166DCKR | JG_ |

- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
- (2) DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.
- (3) **YZPRB is for backside coating

YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



Summary Of Characteristics (1)

| Configuration | Single Pole Single Throw (SPST) |
|--|---------------------------------------|
| Number of channels | 1 |
| ON-state resistance (r _{on}) | 0.9 Ω |
| ON-state resistance flatness (r _{on(flat)}) | 0.15 Ω |
| Turn-on/turn-off time (t _{ON} /t _{OFF}) | 7.5 ns/12.5 ns |
| Charge injection (Q _C) | 1 pC |
| Bandwidth (BW) | 200 MHz |
| OFF isolation (O _{ISO}) | −64 dB at 1 MHz |
| Total harmonic distortion (THD) | 0.005% |
| Leakage current (I _{COM(OFF)}) | ±20 nA |
| Power-supply current (I ₊) | 0.5 μΑ |
| Package option | 5-pin DSBGA, SOT-23, or SC-70 |

(1) $V_+ = 5 \text{ V}, T_A = 25^{\circ}\text{C}$

FUNCTION TABLE

| IN | NO TO COM, COM TO NO |
|----|-------------------------|
| L | OFF |
| Н | ON |

Absolute Maximum Ratings(1) (2)

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|-------------------------------------|---|-------------------------------------|------|----------------------|------|
| V ₊ | Supply voltage range ⁽³⁾ | | -0.5 | 6.5 | V |
| V _{NO} V _{COM} | Analog voltage range ⁽³⁾ (4) (5) | | -0.5 | V ₊ + 0.5 | V |
| I _K | Analog port diode current | $V_{NO}, V_{COM} < 0$ | -50 | | mA |
| I _{NO} | On-state switch current | V V 045 V | -200 | 200 | A |
| I _{COM} | On-state peak switch current ⁽⁶⁾ | V_{NO} , $V_{COM} = 0$ to V_{+} | -400 | 400 | mA |
| VI | Digital input voltage range (3) (4) | • | -0.5 | 6.5 | V |
| I _{IK} | Digital clamp current | V _I < 0 | -50 | | mA |
| I ₊ | Continuous current through V ₊ | | | 100 | mA |
| I _{GND} | Continuous current through GND | | -100 | | mA |
| | | DBV package | | 206 | |
| θ_{JA} | Package thermal impedance ⁽⁷⁾ | DCK package | | 252 | °C/W |
| | | YZP package | | 132 | |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
- (3) All voltages are with respect to ground, unless otherwise specified.
- (4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- (5) This value is limited to 5.5 V maximum.
- (6) Pulse at 1-ms duration < 10% duty cycle.
- (7) The package thermal impedance is calculated in accordance with JESD 51-7.



Electrical Characteristics for 5-V Supply⁽¹⁾

 $V_{+} = 4.5 \text{ V to } 5.5 \text{ V}, T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C} \text{ (unless otherwise noted)}$

| PARAMETER | SYMBOL | TEST CONDIT | TIONS | T _A | V ₊ | MIN | TYP | MAX | UNIT |
|----------------------------|---|---|------------------------------|----------------|----------------|------|------|--|------|
| Analog Switch | | 1 | | I. | 1 | | | | |
| Analog signal range | $V_{\rm COM}, \ V_{\rm NO}$ | | | | | 0 | | V+ | V |
| Peak ON resistance | r _{peak} | $0 \le V_{NO} \le V_+$ | Switch ON, | 25°C | 4.5 V | | 8.0 | 1.1 | Ω |
| T can of Toolstarioo | реак | $I_{COM} = -100 \text{ mA},$ | See Figure 13 | Full | 4.0 V | | | 1.2 | 32 |
| ON-state resistance | r _{on} | $V_{NO} = 2.5 V,$ | Switch ON, | 25°C | 4.5 V | | 0.7 | 0.9 | Ω |
| OIV state resistance | ion | $I_{COM} = -100 \text{ mA},$ | See Figure 13 | Full | 4.0 V | | | 1 | 32 |
| ON-state resistance | | $0 \le V_{NO} \le V_+,$ $I_{COM} = -100 \text{ mA},$ | Switch ON, | 25°C | 45.4 | | 0.15 | | 0 |
| flatness | r _{on(flat)} | V _{NO} = 1 V, 1.5 V, 2.5 V, | See Figure 13 | 25°C | 4.5 V | | 0.09 | 0.15 | Ω |
| | | $I_{COM} = -100 \text{ mA},$ | | Full | | | | 0.15 | |
| | | $V_{NO} = 1 V$ | | 25°C | | -20 | 4 | 20 | |
| NO OFF leakage current | I _{NO(OFF)} | $V_{COM} = 4.5 \text{ V},$ or $V_{NO} = 4.5 \text{ V},$ $V_{COM} = 1 \text{ V},$ | Switch OFF, See Figure 14 | Full | 5.5 V | -100 | | 100 | nA |
| | | $V_{NO} = 0 \text{ to } 5.5 \text{ V},$ | | 25°C | 0.17 | -5 | 0.4 | _ | |
| | I _{NO(PWROFF)} | $V_{COM} = 5.5 \text{ V to } 0,$ | | Full | 0 V | -15 | | 15 | μΑ |
| | | $V_{COM} = 1 V$, | | 25°C | | -20 | 4 | 20 | |
| COM OFF leakage current | $I_{\text{COM(OFF)}} \begin{tabular}{ll} $V_{\text{NO}} = 4.5 \text{ V}, \\ $\text{or} \\ $V_{\text{COM}} = 4.5 \text{ V}, \\ $V_{\text{NO}} = 1 \text{ V}, \\ \end{tabular}$ | $V_{COM} = 4.5 \text{ V},$ | Switch OFF, See Figure 14 | Full | 5.5 V | -100 | | 100 | nA |
| | | $V_{COM} = 5.5 \text{ V to } 0,$ | | 25°C | 0 V | -5 | 0.4 | 5 | |
| | I _{COM(PWROFF)} | $V_{NO} = 0$ to 5.5 V, | | Full | 0 0 | -15 | | 09 0.15 0.15 4 20 100 1.4 5 15 4 20 100 1.4 5 15 3 2 | μΑ |
| | | $V_{NO} = 1 V$, | | 25°C | | -2 | 0.3 | 2 | |
| NO ON leakage current | I _{NO(ON)} | $V_{COM} = Open,$ or $V_{NO} = 4.5 \text{ V},$ $V_{COM} = Open,$ | Switch ON, See Figure 15 | Full | 5.5 V | -20 | | 20 | nA |
| | | $V_{COM} = 1 V$, | | 25°C | | -2 | 0.3 | 2 | |
| COM ON leakage current | I _{COM(ON)} | $\begin{aligned} &V_{NO} = \text{Open,} \\ &\text{or} \\ &V_{COM} = 4.5 \text{ V,} \\ &V_{NO} = \text{Open,} \end{aligned}$ | Switch ON, See Figure 15 | Full | 5.5 V | -20 | | 20 | nA |
| Digital Control Input | s (IN) | | | | • | • | | ' | |
| Input logic high | V _{IH} | | | Full | | 2.4 | | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 | | 0.8 | V |
| Input leakage | 1 1 | V = 5 5 V or 0 | | 25°C | 5 5 V | -2 | 0.3 | 2 | nΛ |
| current | I _{IH} , I _{IL} | $V_1 = 5.5 \text{ V or } 0$ | | Full | 5.5 V | -20 | | 20 | nA |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.



Electrical Characteristics for 5-V Supply⁽¹⁾ (continued)

 $V_{+} = 4.5 \text{ V to } 5.5 \text{ V}, T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C} \text{ (unless otherwise noted)}$

| PARAMETER | SYMBOL | TEST C | ONDITIONS | TA | V+ | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|--|--|------|----------------|-----|-------|------|------|
| Dynamic | | | | | | | | | |
| | | V V | C 25 pF | 25°C | 5 V | 2.5 | 4.5 | 7 | |
| Turn-on time | t _{ON} | $V_{COM} = V_+,$ $R_L = 50 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 4.5 V to 5.5 V | 1.5 | | 7.5 | ns |
| | | V V | 0 25 -5 | 25°C | 5 V | 6 | 9 | 11.5 | |
| Turn-off time | t _{OFF} | $V_{COM} = V_+,$ $R_L = 50 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 4.5 V to 5.5 V | 4 | | 12.5 | ns |
| Charge injection | Q _C | $V_{GEN} = 0,$ $R_{GEN} = 0$, | C _L = 1 nF, See Figure 20 | 25°C | 5 V | | 1 | | рС |
| NO OFF capacitance | C _{NO(OFF)} | V _{NO} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 5 V | | 19 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | V _{COM} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 5 V | | 18 | | pF |
| NO ON capacitance | C _{NO(ON)} | V _{NO} = V ₊ or GND, Switch ON, | See Figure 16 | 25°C | 5 V | | 35.5 | | pF |
| COM ON capacitance | C _{COM(ON)} | $V_{COM} = V_{+}$ or GND, Switch ON, | See Figure 16 | 25°C | 5 V | | 35.5 | | pF |
| Digital input capacitance | Cı | $V_I = V_+ \text{ or GND},$ | See Figure 16 | 25°C | 5 V | | 2 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 5 V | | 200 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 1 MHz, | Switch OFF, See Figure 19 | 25°C | 5 V | | -64 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega,$ $C_L = 50 pF,$ | f = 20 Hz to 20 kHz, See Figure 21 | 25°C | 5 V | | 0.005 | | % |
| Supply | | | | | | | | | |
| Positive supply | I ₊ | $V_1 = V_+ \text{ or GND},$ | Switch ON or OFF | 25°C | 5.5 V | | 0.01 | 0.1 | |
| current | '+ | $v_1 = v_+$ or GND, | SWILLII ON OF OFF | Full | 5.5 V | | | 0.5 | μΑ |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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Electrical Characteristics for 3.3-V Supply⁽¹⁾

 $V_{+} = 3 \text{ V to } 3.6 \text{ V}, T_{A} = -40^{\circ}\text{C to } 85^{\circ}\text{C (unless otherwise noted)}$

| PARAMETER | SYMBOL | TEST CON | DITIONS | TA | V ₊ | MIN | TYP | MAX | UNIT |
|----------------------------|---------------------------------------|---|------------------------------|--------------|----------------|-----|------|--|------|
| Analog Switch | | • | | | • | | | ' | |
| Analog signal range | V _{COM} , V _{NO} | | | | | 0 | | V ₊ | V |
| Peak ON resistance | r _{peak} | $0 \le V_{NO} \le V_{+},$ $I_{COM} = -100 \text{ mA},$ | Switch ON, See Figure 13 | 25°C Full | 3 V | | 1.1 | 1.5 | Ω |
| ON-state resistance | r _{on} | $V_{NO} = 2 \text{ V},$ $I_{COM} = -100 \text{ mA},$ | Switch ON, See Figure 13 | 25°C Full | 3 V | | 1 | 1.4 1.5 | Ω |
| ON-state resistance | | $0 \le V_{NO} \le V_{+},$ $I_{COM} = -100 \text{ mA},$ | Switch ON, | 25°C | 0.1/ | | 0.3 | | |
| flatness | r _{on(flat)} | $V_{NO} = 2 \text{ V}, 0.8 \text{ V},$ $I_{COM} = -100 \text{ mA},$ | See Figure 13 | 25°C Full | 3 V | | 0.09 | 0.15 | Ω |
| | | V _{NO} = 1 V, | | 25°C | | -2 | 0.5 | | |
| NO OFF leakage current | I _{NO(OFF)} | V _{NO} = 3 V, or V _{NO} = 3 V, V _{COM} = 1 V, | Switch OFF, See Figure 14 | Full | 3.6 V | -20 | | 20 | nA |
| | | $V_{NO} = 0 \text{ to } 3.6 \text{ V},$ | | 25°C | 0.17 | -1 | 0.1 | 1 | |
| | I _{NO(PWROFF)} | $V_{COM} = 3.6 \text{ V to 0},$ | | Full | 0 V | -5 | | 5 | μA |
| | | $V_{COM} = 1 V$, | | 25°C | | -2 | 0.5 | 2 | |
| COM OFF leakage current | I _{COM(OFF)} | $V_{NO} = 3 \text{ V},$ or $V_{COM} = 3 \text{ V},$ $V_{NO} = 1 \text{ V},$ | Switch OFF, See Figure 14 | Full | 3.6 V | -20 | | 20 | nA |
| | | $V_{COM} = 3.6 \text{ V to 0},$ | | 25°C | 0.17 | -1 | 0.1 | 1 | |
| | I _{COM(PWROFF)} | $V_{NO} = 0 \text{ to } 3.6 \text{ V},$ | | Full | 0 V | -5 | | 1.5 0.15 0.15 2 20 1 5 2 20 20 2 20 5.5 0.8 | μA |
| | | V _{NO} = 1 V, | | 25°C | | -2 | 0.2 | 2 | |
| NO ON leakage current | I _{NO(ON)} | $V_{COM} = Open,$ or $V_{NO} = 3 V,$ $V_{COM} = Open,$ | Switch ON, See Figure 15 | Full | 3.6 V | -20 | | 20 | nA |
| | | $V_{COM} = 1 V$, | | 25°C | | -2 | 0.2 | 2 | |
| COM ON leakage current | I _{COM(ON)} | V_{NO} = Open, or V_{COM} = 3 V, V_{NO} = Open, | Switch ON, See Figure 15 | Full | 3.6 V | -20 | | 20 | nA |
| Digital Control Inputs | (IN) | • | | | • | | | ' | |
| Input logic high | V _{IH} | | | Full | | 2 | | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 | | 8.0 | V |
| Innut lookogo oursest | | V | | 25°C | 261/ | -2 | 0.3 | 2 | |
| Input leakage current | I _{IH} , I _{IL} | $V_1 = 5.5 \text{ V or } 0$ | | Full | 3.6 V | -20 | | 20 | nA |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



Electrical Characteristics for 3.3-V Supply⁽¹⁾ (continued)

 $V_{+} = 3 \ \underline{V}$ to 3.6 V, $T_{A} = -40 ^{\circ} C$ to 85 $^{\circ} C$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CO | ONDITIONS | T_A | V+ | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|--|--|-------|-----------------|-----|------|------|------|
| Dynamic | | | | | • | | | | |
| | | \/ -\/ | $C_1 = 35 \text{ pF},$ | 25°C | 3.3 V | 2 | 5 | 10 | |
| Turn-on time | t _{ON} | $V_{COM} = V_+,$ $R_L = 50 \Omega,$ | See Figure 17 | Full | 3 V to 3.6 V | 1.5 | | 11 | ns |
| | | V V | 0 25 -5 | 25°C | 3.3 V | 6.5 | 9 | 12 | |
| Turn-off time | t _{OFF} | $V_{COM} = V_+,$ $R_L = 50 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 3 V to 3.6 V | 4 | | 13 | ns |
| Charge injection | Q_{C} | $V_{GEN} = 0,$ $R_{GEN} = 0,$ | C _L = 1 nF, See Figure 21 | 25°C | 3.3 V | | 1 | | рС |
| NO OFF capacitance | C _{NO(OFF)} | V _{NO} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 3.3 V | | 19 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | V _{COM} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 3.3 V | | 18 | | pF |
| NO ON capacitance | C _{NO(ON)} | V _{NO} = V ₊ or GND, Switch ON, | See Figure 16 | 25°C | 3.3 V | | 36 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = V ₊ or GND, Switch ON, | See Figure 16 | 25°C | 3.3 V | | 36 | | pF |
| Digital input capacitance | C _I | $V_I = V_+ \text{ or GND},$ | See Figure 16 | 25°C | 3.3 V | | 2 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 3.3 V | | 200 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 1 MHz, | Switch OFF, See Figure 19 | 25°C | 3.3 V | | -64 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega,$ $C_L = 50 pF,$ | f = 20 Hz to 20 kHz, See Figure 21 | 25°C | 3.3 V | | 0.01 | | % |
| Supply | | | | | | | | | |
| Positive supply | I ₊ | $V_1 = V_+$ or GND, | Switch ON or OFF | 25°C | 3.6 V | | 0.01 | 0.1 | μA |
| current | '+ | VI - V+ OI GIND, | SWILLII ON UI OFF | Full | 3.0 v | | | 0.25 | μΛ |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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Electrical Characteristics for 2.5-V Supply⁽¹⁾

 $\mbox{V}_{+} = 2.3 \mbox{ V to } 2.7 \mbox{ V}, \mbox{ } \mbox{T}_{\mbox{\scriptsize A}} = -40 \mbox{\ensuremath{^{\circ}}}\mbox{C} \mbox{ to } 85 \mbox{\ensuremath{^{\circ}}}\mbox{C} \mbox{ (unless otherwise noted)}$

| PARAMETER | SYMBOL | TEST CON | DITIONS | T _A | V ₊ | MIN | TYP | MAX | UNIT |
|----------------------------|---------------------------------------|--|------------------------------|----------------|----------------|------------|------|-------------------------------------|------|
| Analog Switch | | | | | | | | | |
| Analog signal range | V _{COM} , V _{NO} | | | | 2.3 V | 0 | | V ₊ | V |
| Peak ON resistance | r _{peak} | $0 \le V_{NO} \le V_{+},$ $I_{COM} = -100 \text{ mA},$ | Switch ON, See Figure 13 | 25°C Full | 2.3 V | | 1.8 | 2.4 | Ω |
| ON-state resistance | r _{on} | $V_{NO} = 2 V$, $I_{COM} = -100 \text{ mA}$, | Switch ON, See Figure 13 | 25°C Full | 2.3 V | | 1.2 | 2.1 2.4 | Ω |
| ON-state resistance | | $0 \le V_{NO} \le V_{+},$ $I_{COM} = -100 \text{ mA},$ | Switch ON, | 25°C | | | 0.7 | | |
| flatness | r _{on(flat)} | $V_{NO} = 2 \text{ V}, 0.8 \text{ V},$ $I_{COM} = -100 \text{ mA},$ | See Figure 13 | 25°C Full | 2.3 V | | 0.4 | 0.6 | Ω |
| | | $V_{NO} = 1 \text{ V},$ | | 25°C | | - 5 | 0.3 | | |
| NO OFF leakage current | I _{NO(OFF)} | V _{COM} = 3 V, or V _{NO} = 3 V, V _{COM} = 1 V, | Switch OFF, See Figure 14 | Full | 2.7 V | -50 | 0.0 | 50 | nA |
| | | $V_{NO} = 0 \text{ to } 3.6 \text{ V},$ | | 25°C | | -2 | 0.05 | 2 | |
| | I _{NO(PWROFF)} | $V_{COM} = 3.6 \text{ V to 0},$ | | Full | 0 V | -15 | | 15 | μΑ |
| | | $V_{COM} = 1 V$, | | 25°C | | - 5 | 0.3 | 5 | |
| COM OFF leakage current | I _{COM(OFF)} | $V_{NO} = 3 \text{ V},$ or $V_{COM} = 3 \text{ V},$ $V_{NO} = 1 \text{ V},$ | Switch OFF, See Figure 14 | Full | 2.7 V | -50 | | 50 | nA |
| | | $V_{COM} = 3.6 \text{ V to } 0,$ | | 25°C | 0.17 | -2 | 0.05 | 2 | |
| | I _{COM(PWROFF)} | $V_{NO} = 0 \text{ to } 3.6 \text{ V},$ | | Full | 0 V | -15 | | 2.4 0.6 0.6 5 50 2 15 50 2 15 2 20 | μA |
| | | V _{NO} = 1 V, | | 25°C | | -2 | 0.3 | 2 | |
| NO ON leakage current | I _{NO(ON)} | $V_{COM} = Open,$ or $V_{NO} = 3 V,$ $V_{COM} = Open,$ | Switch ON, See Figure 15 | Full | 2.7 V | -20 | | 20 | nA |
| | | $V_{COM} = 1 V$, | | 25°C | | -2 | 0.3 | 2 | |
| COM ON leakage current | I _{COM(ON)} | V_{NO} = Open, or V_{COM} = 3 V, V_{NO} = Open, | Switch ON, See Figure 15 | Full | 2.7 V | -20 | | 20 | nA |
| Digital Control Inputs | (IN1, IN2) | | | | | | | | |
| Input logic high | V _{IH} | | | Full | | 1.8 | | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 | | 0.6 | V |
| Innut lookogo oursest | | V | | 25°C | 271/ | -2 | 0.3 | 2 | ~ ^ |
| Input leakage current | I _{IH} , I _{IL} | $V_1 = 5.5 \text{ V or } 0$ | | Full | 2.7 V | -20 | | 20 | nA |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



Electrical Characteristics for 2.5-V Supply⁽¹⁾ (continued)

 $V_{+} = 2.3 \text{ V}$ to 2.7 V, $T_{A} = -40^{\circ}\text{C}$ to 85°C (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CO | ONDITIONS | T_A | V+ | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|--|--|-------|-------------------|-----|-------|------|------|
| Dynamic | | | | | • | | | | |
| | | V - V | C _L = 35 pF, | 25°C | 2.5 V | 2 | 6 | 10 | |
| Turn-on time | t _{ON} | $V_{COM} = V_+,$ $R_L = 50 \Omega,$ | See Figure 17 | Full | 2.3 V to 2.7 V | 1 | | 12 | ns |
| | | V V | 0 25 5 | 25°C | 2.5 V | 4.5 | 8 | 10.5 | |
| Turn-off time | t _{OFF} | $V_{COM} = V_+,$ $R_L = 50 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 2.3 V to 2.7 V | 3 | | 15 | ns |
| Charge injection | Q _C | $V_{GEN} = 0,$ $R_{GEN} = 0,$ | $C_L = 1 \text{ nF},$ See Figure 21 | 25°C | 2.5 V | | 4 | | рС |
| NO OFF capacitance | C _{NO(OFF)} | V _{NO} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 2.5 V | | 19.5 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | V _{COM} = V ₊ or GND, Switch OFF, | See Figure 16 | 25°C | 2.5 V | | 18.5 | | pF |
| NO ON capacitance | C _{NO(ON)} | V _{NO} = V ₊ or GND, Switch ON, | See Figure 16 | 25°C | 2.5 V | | 36.5 | | pF |
| COM ON capacitance | C _{COM(ON)} | $V_{COM} = V_{+}$ or GND, Switch ON, | See Figure 16 | 25°C | 2.5 V | | 36.5 | | pF |
| Digital input capacitance | Cı | $V_I = V_+ \text{ or GND},$ | See Figure 16 | 25°C | 2.5 V | | 2 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 2.5 V | | 150 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 1 MHz, | Switch OFF, See Figure 19 | 25°C | 2.5 V | | -62 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega,$ $C_L = 50 pF,$ | f = 20 Hz to 20 kHz, See Figure 21 | 25°C | 2.5 V | | 0.02 | | % |
| Supply | | | | | | | | | |
| Positive supply | 1 | $V_1 = V_+$ or GND, | Switch ON or OFF | 25°C | 2.7 V | | 0.001 | 0.02 | пΔ |
| current | I ₊ | VI - V+ OI GIND, | SWILLII ON OI OFF | Full | Z.1 V | | | 0.25 | μΑ |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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Electrical Characteristics for 1.8-V Supply⁽¹⁾

 $V_{+} = 1.65 \text{ V}$ to 1.95 V, $T_{A} = -40 ^{\circ}\text{C}$ to $85 ^{\circ}\text{C}$ (unless otherwise noted))

| PARAMETER | SYMBOL | TEST CON | DITIONS | T _A | V ₊ | MIN | TYP | MAX | UNIT |
|----------------------------|---------------------------------------|---|------------------------------|----------------|----------------|------------|-----|--|------|
| Analog Switch | | | | | • | • | | | |
| Analog signal range | V _{COM} , V _{NO} | | | | | 0 | | V ₊ | V |
| Peak ON resistance | r _{peak} | $0 \le V_{NO} \le V_{+},$ $I_{COM} = -100 \text{ mA},$ | Switch ON, See Figure 13 | 25°C Full | 1.65 V | | 4.2 | 25 30 | Ω |
| ON-state resistance | r _{on} | $V_{NO} = 2 \text{ V},$ $I_{COM} = -100 \text{ mA},$ | Switch ON, See Figure 13 | 25°C Full | 1.65 V | | 1.6 | 3.9 4.0 | Ω |
| ON-state resistance | | $0 \le V_{NO} \le V_{+},$ $I_{COM} = -100 \text{ mA},$ | Switch ON, | 25°C | 4.05.1/ | | 2.8 | | |
| flatness | r _{on(flat)} | $V_{NO} = 2 \text{ V}, 0.8 \text{ V},$ $I_{COM} = -100 \text{ mA},$ | See Figure 13 | 25°C Full | 1.65 V | | 4.1 | 22 27 | Ω |
| | | V _{NO} = 1 V, | | 25°C | | -5 | | | |
| NO OFF leakage current | I _{NO(OFF)} | V _{NO} = 3 V, or V _{NO} = 3 V, V _{COM} = 1 V, | Switch OFF, See Figure 14 | Full | 1.95 V | -50 | | 50 | nA |
| | 1 | $V_{NO} = 0 \text{ to } 3.6 \text{ V},$ | | 25°C | 0 V | -2 | | 2 | μA |
| | I _{NO(PWROFF)} | $V_{COM} = 3.6 \text{ V to } 0,$ | | Full | 0 0 | -10 | | 10 | μΛ |
| | | $V_{COM} = 1 V$ | | 25°C | | - 5 | 5 | | |
| COM OFF leakage current | I _{COM(OFF)} | $V_{NO} = 3 V$, or $V_{COM} = 3 V$, $V_{NO} = 1 V$, | Switch OFF, See Figure 14 | Full | 1.95 V | -50 | | 50 | nA |
| | | $V_{COM} = 0 \text{ to } 3.6 \text{ V},$ | | 25°C | 0 V | -2 | | 2 | |
| | I _{COM(PWROFF)} | $V_{NO} = 3.6 \text{ V to } 0,$ | | Full | 0 0 | -10 | | 4.0 2.8 4.1 22 27 5 50 2 10 50 | μΑ |
| | | $V_{NO} = 1 V$, | | 25°C | | -2 | | 2 | |
| NO ON leakage current | I _{NO(ON)} | $V_{COM} = Open,$ or $V_{NO} = 3 V,$ $V_{COM} = Open,$ | Switch ON, See Figure 15 | Full | 1.95 V | -20 | | 20 | nA |
| | | $V_{COM} = 1 V$, | | 25°C | | -2 | | 2 | |
| COM ON leakage current | I _{COM(ON)} | V_{NO} = Open, or V_{COM} = 3 V, V_{NO} = Open, | Switch ON, See Figure 15 | Full | 1.95 V | -20 | | 20 | nA |
| Digital Control Inputs | (IN1, IN2) | | | | | | | | |
| Input logic high | V _{IH} | | | Full | | 1.5 | | 5.5 | V |
| Input logic low | V _{IL} | | | Full | | 0 | | 0.6 | V |
| Input lookage current | | V _I = 5.5 V or 0 | | 25°C | 1.95 V | -2 | 0.3 | 2 | nΛ |
| Input leakage current | I _{IH} , I _{IL} | v ₁ = 3.3 v 01 0 | | Full | 1.90 V | -20 | | 20 | nA |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum



Electrical Characteristics for 1.8-V Supply⁽¹⁾ (continued)

 V_{+} = 1.65 V to 1.95 V, T_{A} = -40°C to 85°C (unless otherwise noted))

| PARAMETER | SYMBOL | TEST CO | ONDITIONS | T_A | V+ | MIN | TYP | MAX | UNIT |
|---------------------------|-----------------------|--|--|-------|---------------------|-----|-------|------|------|
| Dynamic | | | | | | | | | |
| | | \ \ \ - \\ \ | C = 25 pE | 25°C | 1.8 V | 3 | 9 | 18 | |
| Turn-on time | t _{ON} | $V_{COM} = V_+,$ $R_L = 50 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 1.65 V to 1.95 V | 1 | | 20 | ns |
| | | | 0 25 - 5 | 25°C | 1.8 V | 5 | 10 | 15.5 | |
| Turn-off time | t _{OFF} | $V_{COM} = V_+,$ $R_L = 50 \Omega,$ | C _L = 35 pF, See Figure 17 | Full | 1.65 V to 1.95 V | 4 | | 18.5 | ns |
| Charge injection | $Q_{\mathbb{C}}$ | $V_{GEN} = 0,$ $R_{GEN} = 0,$ | $C_L = 1 \text{ nF},$ See Figure 21 | 25°C | 1.8 V | | 2 | | рС |
| NO OFF capacitance | C _{NO(OFF)} | $V_{NO} = V_{+}$ or GND, Switch OFF, | See Figure 16 | 25°C | 1.8 V | | 19.5 | | pF |
| COM OFF capacitance | C _{COM(OFF)} | $V_{COM} = V_{+}$ or GND, Switch OFF, | See Figure 16 | 25°C | 1.8 V | | 18.5 | | pF |
| NO ON capacitance | C _{NO(ON)} | $V_{NO} = V_{+}$ or GND, Switch ON, | See Figure 16 | 25°C | 1.8 V | | 36.5 | | pF |
| COM ON capacitance | C _{COM(ON)} | $V_{COM} = V_{+}$ or GND, Switch ON, | See Figure 16 | 25°C | 1.8 V | | 36.5 | | pF |
| Digital input capacitance | C _I | $V_I = V_+ \text{ or GND},$ | See Figure 16 | 25°C | 1.8 V | | 2 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Switch ON, | See Figure 18 | 25°C | 1.8 V | | 150 | | MHz |
| OFF isolation | O _{ISO} | $R_L = 50 \Omega$, f = 1 MHz, | Switch OFF, See Figure 19 | 25°C | 1.8 V | | -62 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega,$ $C_L = 50 pF,$ | f = 20 Hz to 20 kHz See Figure 21 | 25°C | 1.8 V | | 0.055 | | % |
| Supply | | | | | | | | | |
| Positive supply | I ₊ | $V_1 = V_+ \text{ or GND},$ | Switch ON or OFF | 25°C | 1.95 V | | 0.001 | 0.01 | μA |
| current | '+ | 1, 1, 0, 0, 15, | 5ton 511 51 1 | Full | 1.00 1 | | | 0.15 | μ, , |

⁽¹⁾ The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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TYPICAL PERFORMANCE

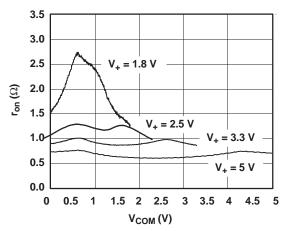


Figure 1. ron vs V_{COM}

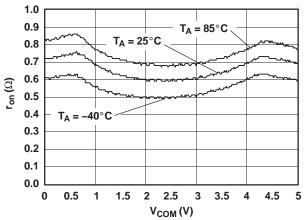


Figure 3. r_{on} vs V_{COM} ($V_{+} = 5 V$)

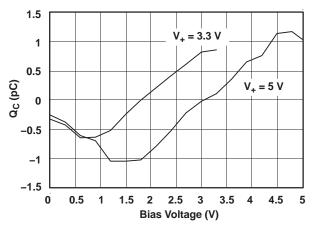


Figure 5. Charge Injection (Q_C) vs V_{COM}

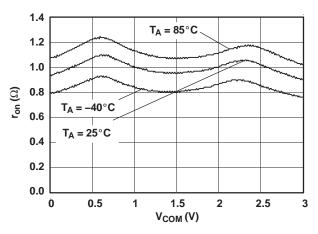


Figure 2. r_{on} vs V_{COM} ($V_{+} = 3 \text{ V}$)

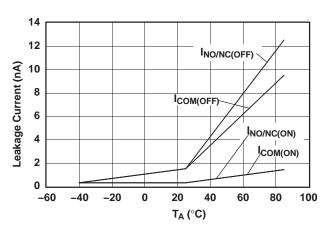


Figure 4. Leakage Current vs Temperature (V₊ = 5.5 V)

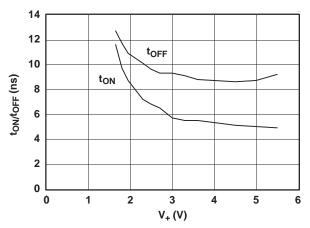
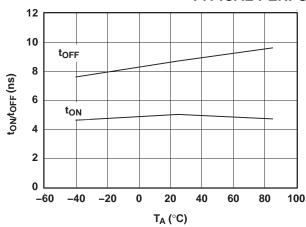


Figure 6. t_{ON} and t_{OFF} vs Supply Voltage







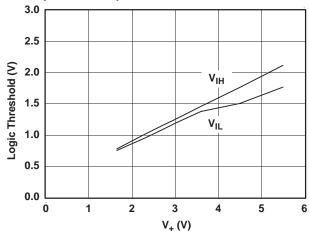
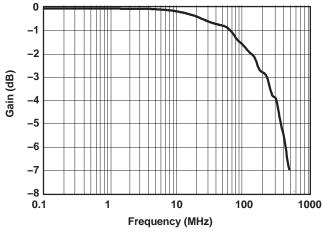


Figure 7. t_{ON} and t_{OFF} vs Temperature (V₊ = 5 V)

Figure 8. Logic Threshold vs V₊



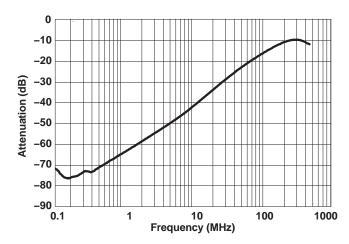
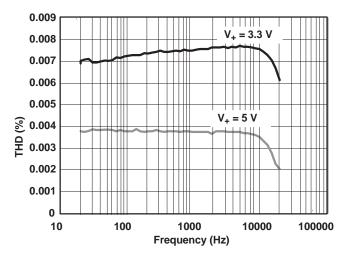


Figure 9. Gain vs Frequency $(V_+ = 5 V)$

Figure 10. OFF Isolation vs Frequency $(V_+ = 5 \text{ V})$



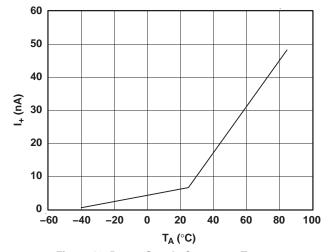


Figure 11. Total Harmonic Distortion vs Frequency $(V_+ = 5 \text{ V})$

Figure 12. Power-Supply Current vs Temperature $(V_+ = 5 V)$

Table 1. PIN DESCRIPTION

| | | DECODIDATION |
|------------|------|-----------------|
| PIN NUMBER | NAME | I DESCRIPTION |
| | NO- | Normally closed |
| 2 | COM | Common |
| | | 19911111911 |



TYPICAL PERFORMANCE (continued) Table 1. PIN DESCRIPTION (continued)

| PIN NUMBER NAM | VII— | DESCRIPTION |
|----------------|------|------------------|
| GN GN | ir. | Digital ground . |
| Y YN | | |
| 4 (1) | | |
| 5 V | 1 | Power Supply' |

PARAMETER DESCRIPTION

| | PARAMETER DESCRIPTION |
|--|--|
| . SYMBOL | DESCRIPTION |
| VcoM | Voltage at COM |
| VCOM VNO | Voltage at NO Resistance between COM and NO ports when the channel is ON |
| on | Resistance petwern Colvi and no polits when the channel is on |
| on peak on(flat) | Difference between the maximum and minimum value of r in a channel over the specified range of conditions |
| on(flat) | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state under worst-case |
| NO(OFF) | input and output conditions |
| NO(PWROFF) | eakage current measured at the NO port during the power-down condition. |
| COM(OFF) | Leakage current reasoned at the COM port, with the corresponding challing (COM to NO) in the OFF state under worst-case |
| COM(DIMPOFF) | Resistance between COM and NO ports when the channel is ON peak on-state resistance over a specified voltage range. Difference between the maximum and minimum value of range. Difference between the maximum and minimum value of range. Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state under worst-case input and output conditions. Leakage current measured at the COM port during the power-down condition. V = 0 Leakage current measured at the COM port during the power-down condition. Leakage current measured at the COM port during the power-down condition. V = 0 Leakage current measured at the COM port during the power-down condition. V = 0 Leakage current measured at the COM port, with the corresponding channel (NO to COM) in the ON state and the output (COM) open. |
| COM(PWROFF) | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output |
| NO(ON) | (CQMP open |
| I _{COM(ON)} | teakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON state and the output |
| Viu | Minimum induit voltage for logic high for the control induit (IIX) |
| XIII XIII | Maximum input voltage for logic low for the control input (IN) |
| | Voltage at the control input (IN) |
| ľih, lil | Leakage current measured at the control input (IN) |
| t _{ON} | between the douted control (I.M.) sparal and analog output (COP) or System and when the switch is during OP. |
| t _{OFF} | Leakage current measured at the control input (till) runner time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON. Turn-off time tot the switch. It is parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection (C) = C X X C X C X I the load capacitance and X X X I the COM or When the corresponding channel (NOX) is OFF. |
| _ | Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM) output. |
| Q_{C} | lihis is measured in coulomb.(C) and measured by the total charge induced due to switching of the control input. Charge ' |
| | injection $Q_c = Q_L \times AV_C$ with the load capacitance and $AV_C = Q_L \times AV_C$ and $Q_c = Q_L \times AV_C$ with the load capacitance and $AV_C = Q_L \times AV_C$ and $Q_c = Q_L \times AV_C$ with the load capacitance and $Q_c = Q_L \times AV_C$ and $Q_c = Q_L \times AV_C$ with the load capacitance and $Q_c = Q_L \times AV_C$ an |
| MO(OFF)_ | Cabacitance at the NO Wort when the corresponding channel (COW) is OFF |
| CNO(ON) | Cabacilance at the COM port when the corresponding channel ICOM to NOI is OFF Cabacilance at the NO port when the corresponding channel INO to COM is ON. |
| NO(OFF) COM(OFF) NO(ON) COM(ON) | |
| Chow(out) | Cabacitance of control input (IN) |
| O _{ISO} BW | OFF Isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state. |
| BW | Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain. |
| THD | Capacitative at the swinch lighten the control of the specific frequency, which is a measured in dB in a specific frequency, with the swinch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the presponding channel is 10 to COW in the OFF state. Bandwidth of the switch in the DC gain. Total harmonic distortion describes the sinal distortion caused by the analog switch. This is defined as the ratio of root mean static power-supply current with the control (higher harmonic to the absolute magnitude of the fundamental harmonic. |
| _ | Static power-supply current with the control (IN) bin at V, or GND |

PARAMETER MEASUREMENT INFORMATION

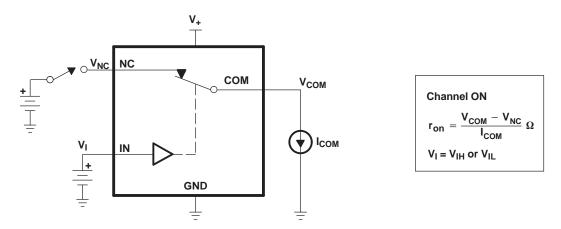


Figure 13. ON-State Resistance (r_{on})



PARAMETER MEASUREMENT INFORMATION (continued)

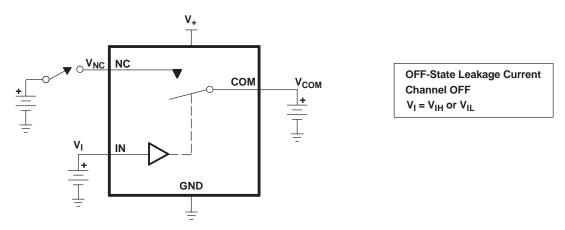


Figure 14. OFF-State Leakage Current ($I_{COM(OFF)}$, $I_{NO(OFF)}$, $I_{COM(PWROFF)}$, $I_{NO(PWR(FF))}$)

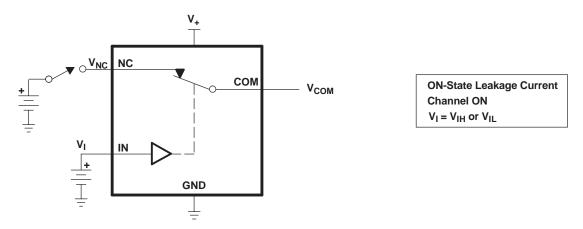


Figure 15. ON-State Leakage Current ($I_{COM(ON)}$, $I_{NO(ON)}$)

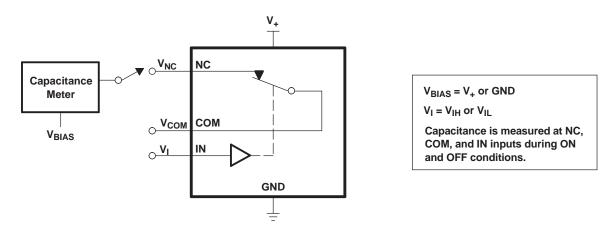
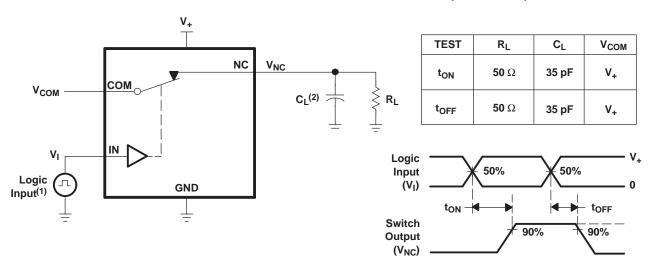


Figure 16. Capacitance (C_I, $C_{COM(OFF)}$, $C_{COM(ON)}$, $C_{NO(OFF)}$, $C_{NO(ON)}$)

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PARAMETER MEASUREMENT INFORMATION (continued)



- (1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r < 5 \text{ ns}$, $t_f < 5 \text{ ns}$.
- (2) C_L includes probe and jig capacitance.

Figure 17. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})

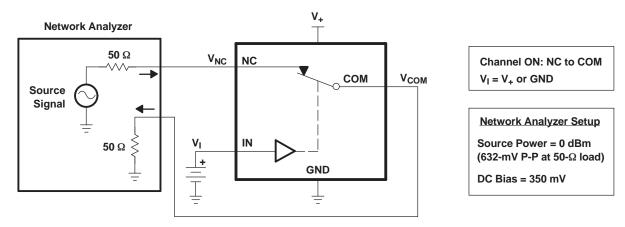


Figure 18. Bandwidth (BW)

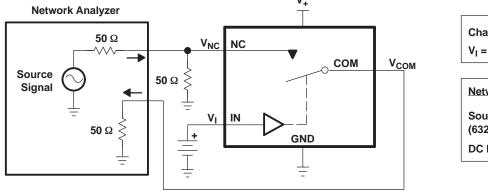


Figure 19. OFF Isolation (O_{ISO})

Channel OFF: NC to COM $V_1 = V_+$ or GND

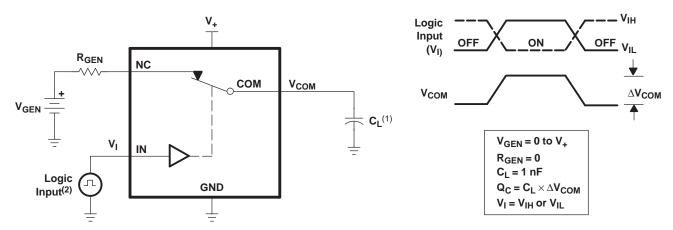
Network Analyzer Setup

Source Power = 0 dBm
(632-mV P-P at 50-Ω load)

DC Bias = 350 mV

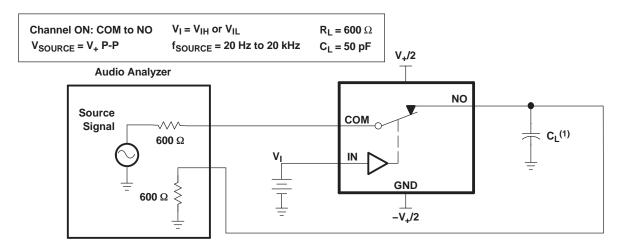


PARAMETER MEASUREMENT INFORMATION (continued)



- (1) C_L includes probe and jig capacitance.
- (2) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r < 5 \text{ ns}$, $t_f < 5 \text{ ns}$.

Figure 20. Charge Injection (Q_C)



(1) C_L includes probe and jig capacitance.

Figure 21. Total Harmonic Distortion (THD)

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REVISION HISTORY

| Changes from Original (February 2005) to Revision A | | | | |
|---|-------------------------------------|---|--|--|
| • | Updated ORDERING INFORMATION table. | 1 | | |





4-Oct-2012

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Peak Temp ⁽³⁾ | Samples (Requires Login) |
|------------------|-----------------------|--------------|--------------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| TS5A3166DBVR | ACTIVE | SOT-23 | DBV | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| TS5A3166DBVRE4 | ACTIVE | SOT-23 | DBV | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| TS5A3166DBVRG4 | ACTIVE | SOT-23 | DBV | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| TS5A3166DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| TS5A3166DCKRE4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| TS5A3166DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| TS5A3166YZPR | ACTIVE | DSBGA | YZP | 5 | 3000 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM | |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM

4-Oct-2012

continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| di diniciisions ale nominai | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| TS5A3166DBVR | SOT-23 | DBV | 5 | 3000 | 178.0 | 9.0 | 3.23 | 3.17 | 1.37 | 4.0 | 8.0 | Q3 |
| TS5A3166DCKR | SC70 | DCK | 5 | 3000 | 178.0 | 9.0 | 2.4 | 2.5 | 1.2 | 4.0 | 8.0 | Q3 |
| TS5A3166YZPR | DSBGA | YZP | 5 | 3000 | 178.0 | 9.2 | 1.02 | 1.52 | 0.63 | 4.0 | 8.0 | Q1 |

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TS5A3166DBVR | SOT-23 | DBV | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TS5A3166DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 180.0 | 18.0 |
| TS5A3166YZPR | DSBGA | YZP | 5 | 3000 | 220.0 | 220.0 | 35.0 |

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-178 Variation AA.



DBV (R-PDSO-G5)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AA.



DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



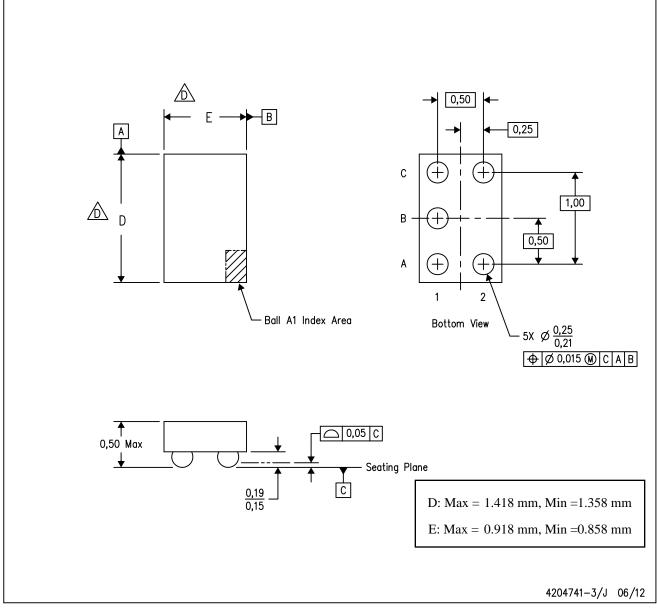
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



YZP (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. NanoFree™ package configuration.
- The package size (Dimension D and E) of a particular device is specified in the device Product Data Sheet version of this drawing, in case it cannot be found in the product data sheet please contact a local TI representative.
- E. This package is a Pb-free solder ball design. Refer to the 5 YEP package (drawing 4204725) for tin-lead (SnPb).

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